# 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 40 V
- Low forward voltage V<sub>F</sub> ≤ 600 mV
- Low reverse current
- AEC-Q101 qualified
- · Solderable side pads
- Package height typ. 0.37 mm
- · Ultra small and leadless SMD plastic package

# 3. Applications

- Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch mode power supply
- LED backlight for mobile application
- Low power consumption applications
- · Ultra high-speed switching
- · Reverse polarity protection

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; f = 20 kHz; $T_{amb} \le 90 ^{\circ}\text{C}$ ; square wave	[1]	-	-	1	Α
		$\delta$ = 0.5 ; f = 20 kHz; $T_{sp} \le 135$ °C; square wave		-	-	1	Α
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	-	40	V
V <sub>F</sub>	forward voltage	$I_F = 1 \text{ A}; t_p \le 300  \mu\text{s}; \delta \le 0.02 ;$ pulsed; $T_j = 25 ^{\circ}\text{C}$		-	540	600	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C		-	0.6	4	μΑ



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(meas)} = 0.1 \text{ A}$ ; $T_j = 25 \text{ °C}$	-	3	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к <b>_}</b> А
2	А	anode	1 2	sym001
			Transparent top view DFN1608D-2 (SOD1608)	

[1] The marking bar indicates the cathode.

# 6. Ordering information

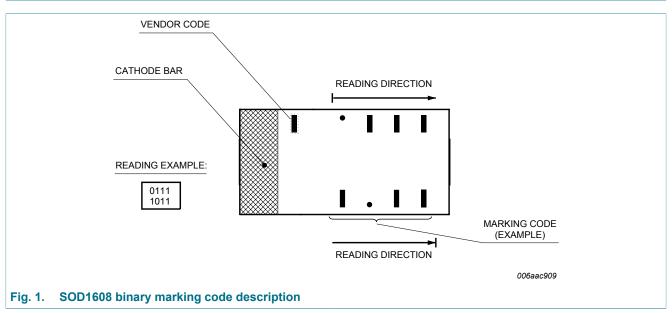
### **Table 3. Ordering information**

Type number	Package				
	Name	Description	Version		
PMEG4010EPK	DFN1608D-2	DFN1608D-2: leadless ultra small plastic package; 2 terminals	SOD1608		

# 7. Marking

### Table 4. Marking codes

Type number	Marking code
PMEG4010EPK	1010 0000



# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	40	V
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 130 °C		-	1.4	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; f = 20 kHz; $T_{amb} \le 90$ °C; square wave	[1]	-	1	Α
		$\delta$ = 0.5 ; f = 20 kHz; $T_{sp} \le 135$ °C; square wave		-	1	Α
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25$		-	3	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	5	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2] [3]	-	410	mW
			[4] [3]	-	860	mW
			[1] [3]	-	1565	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Reflow soldering is the only recommended soldering method.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to	in free air	[1] [2] [3]	-	-	305	K/W
	ambient		[1] [4] [3]	-	-	145	K/W
			[1] [5] [3]	-	-	80	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[6]	-	-	20	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Reflow soldering is the only recommended soldering method.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [6] Soldering point of cathode tab.

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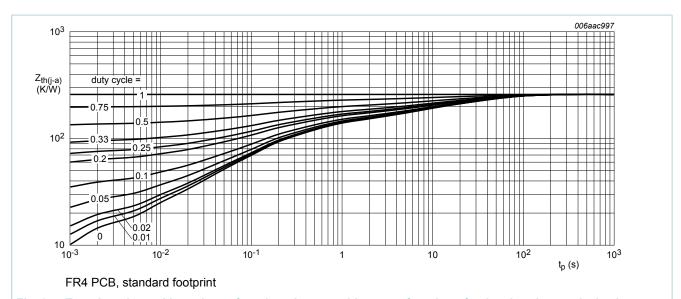


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

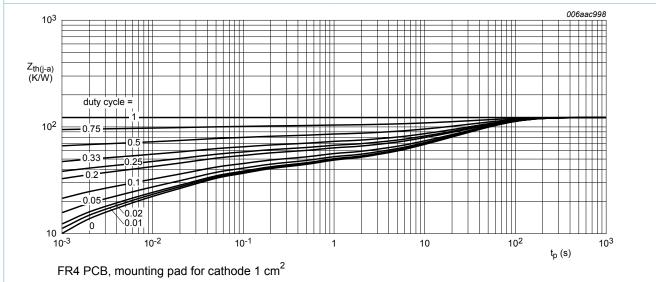
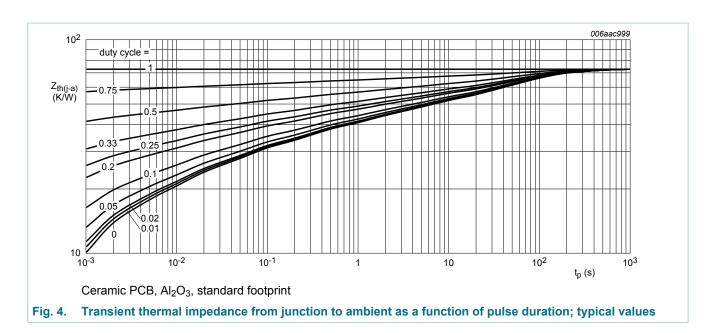


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

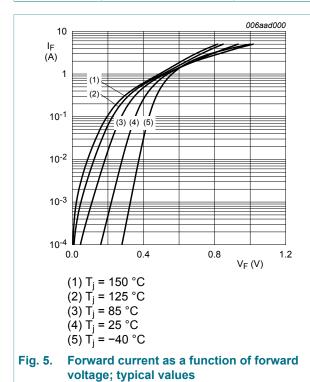


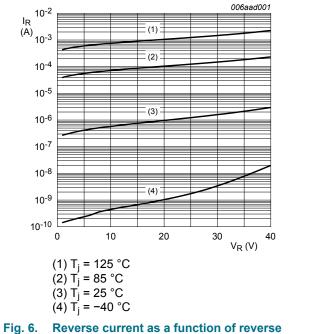
**Product data sheet** 

# 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	l N	/lin	Тур	Max	Unit
V <sub>F</sub>	forward voltage	$I_F$ = 100 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; pulsed; $T_j$ = 25 °C	-		345	390	mV
		$I_F$ = 500 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; pulsed; $T_j$ = 25 °C	-		440	500	mV
		$I_F$ = 700 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; pulsed; $T_j$ = 25 °C	-		480	550	mV
		$I_F = 1 \text{ A}; t_p \le 300  \mu\text{s}; \delta \le 0.02 ;$ pulsed; $T_j = 25 ^{\circ}\text{C}$	-		540	600	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-		0.6	4	μA
		V <sub>R</sub> = 40 V; T <sub>j</sub> = 25 °C	-		3	20	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-		50	60	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-		20	25	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(meas)} = 0.1 \text{ A}$ ; $I_{j} = 25 \text{ °C}$	-		3	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$	-		460	-	mV





voltage; typical values

Nexperia PMEG4010EPK

### 40 V, 1 A low VF MEGA Schottky barrier rectifier

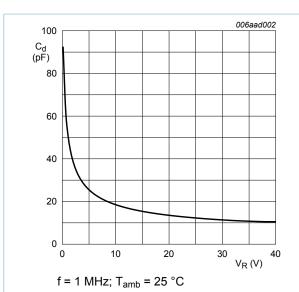


Fig. 7. Diode capacitance as a function of reverse voltage; typical values

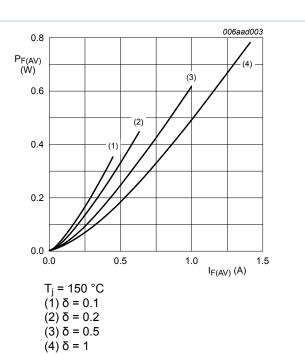
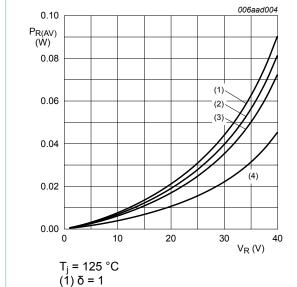
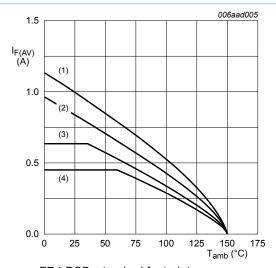


Fig. 8. Average forward power dissipation as a function of average forward current; typical values



(2)  $\delta = 0.9$ (3)  $\delta = 0.8$ (4)  $\delta = 0.5$ 

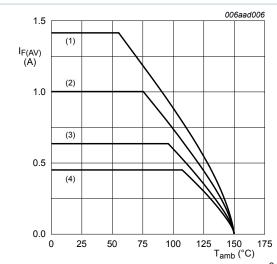
Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint  $T_j = 150 \,^{\circ}\text{C}$  (1)  $\delta = 1 \, (DC)$  (2)  $\delta = 0.5$ ; f = 20 kHz (3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 150 \, ^{\circ}C$ 

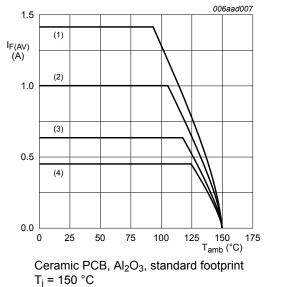
 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



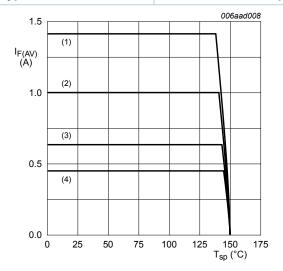
 $(1) \delta = 1 (DC)$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



 $T_j$  = 150 °C

 $(1) \delta = 1 (DC)$ 

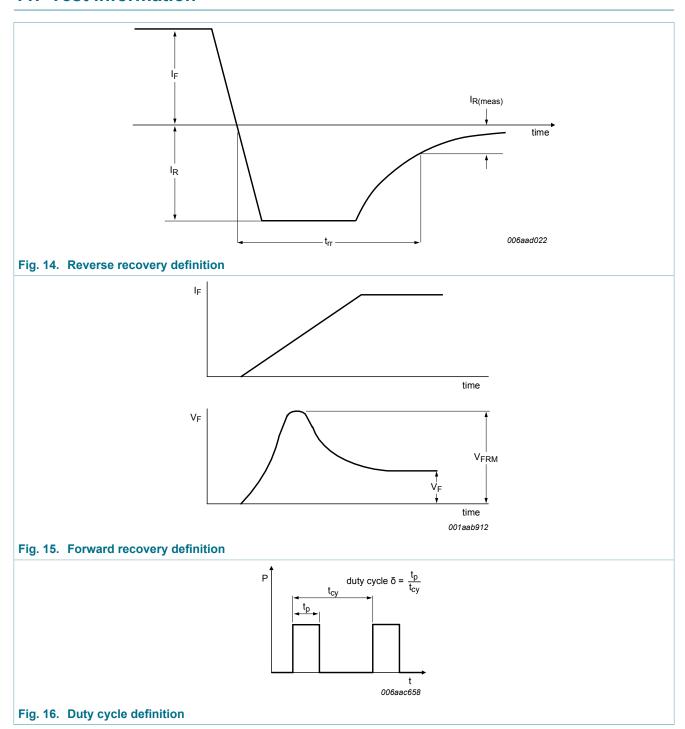
(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 13. Average forward current as a function of solder point temperature; typical values

# 11. Test information

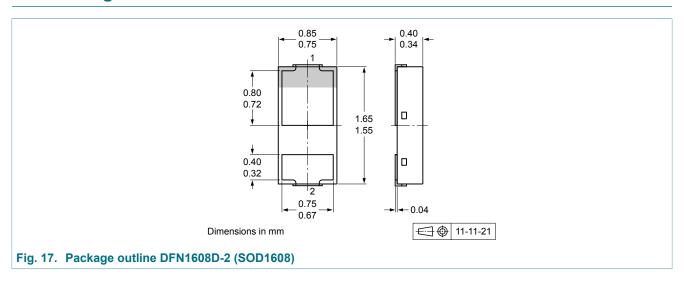


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

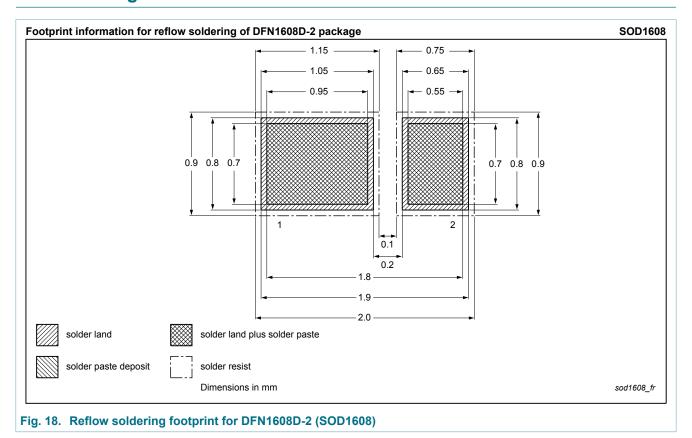
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



# 13. Soldering



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40 V, 1 A low VF MEGA Schottky barrier rectifier

# 14. Revision history

### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMEG4010EPK v.3	20180118	Product data sheet	-	PMEG4010EPK_2		
Modifications:	<ul> <li>The format of this datasheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
PMEG4010EPK_2	20120306	Product data sheet	-	PMEG4010EPK_1		
PMEG4010EPK_1	20120302	Product data sheet	-	-		

# 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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# PMEG4010EPK

# 40 V, 1 A low VF MEGA Schottky barrier rectifier

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